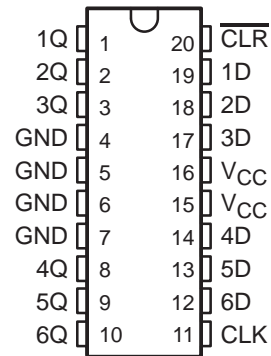


# 74AC11174 HEX D-TYPE FLIP-FLOP WITH CLEAR

SCAS146 – MARCH 1990 – REVISED APRIL 1993

- Applications Include: Buffer/Storage Registers, Shift Registers, Pattern Generators
- Flow-Through Architecture Optimizes PCB Layout
- Center-Pin  $V_{CC}$  and GND Pin Configurations Minimize High-Speed Switching Noise
- EPIC™ (Enhanced-Performance Implanted CMOS) 1- $\mu$ m Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages and Standard Plastic 300-mil DIPs

DW OR N PACKAGE  
(TOP VIEW)



## description

This device contains six D-type flip-flops and is positive-edge-triggered with a direct clear input. Information at the D inputs meeting the setup time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the high or low level, the D input signal has no effect at the output.

The 74AC11174 is characterized for operation from  $-40^{\circ}\text{C}$  to  $85^{\circ}\text{C}$ .

FUNCTION TABLE

INPUTS			OUTPUT
CLR	CLK	D	Q
L	X	X	L
H	↑	H	H
H	↑	L	L
H	L	X	$Q_0$

EPIC is a trademark of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



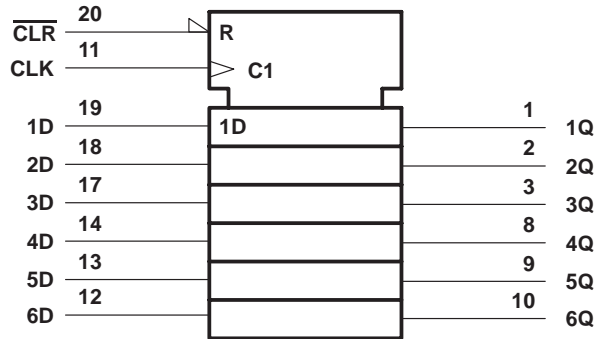
POST OFFICE BOX 655303 • DALLAS, TEXAS 75265

Copyright © 1993, Texas Instruments Incorporated

# 74AC11174 HEX D-TYPE FLIP-FLOP WITH CLEAR

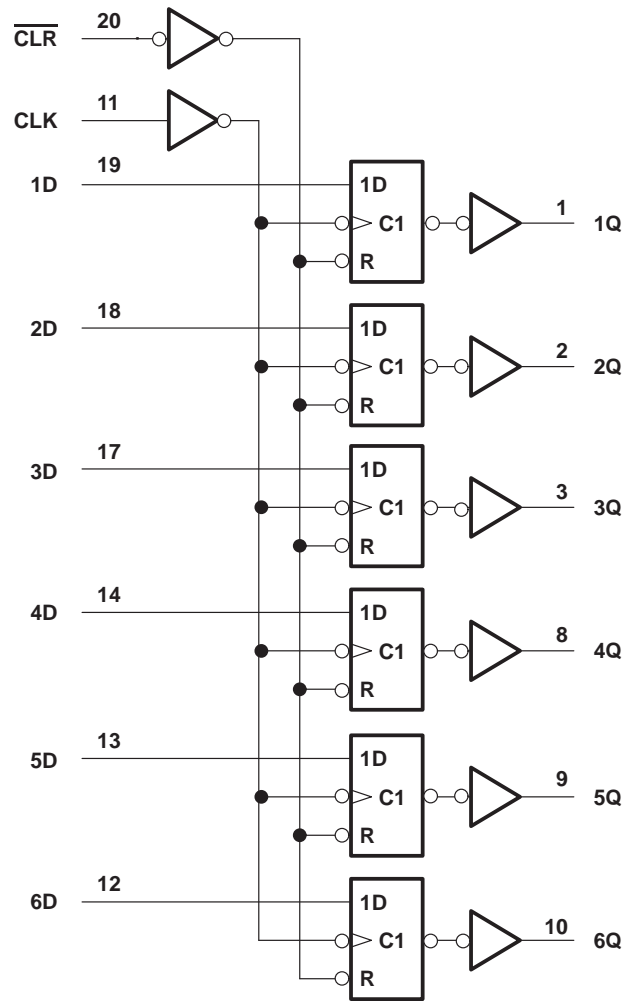
SCAS146 – MARCH 1990 – REVISED APRIL 1993

## logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, $V_{CC}$ .....	-0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1) .....	-0.5 V to $V_{CC} + 0.5$ V
Output voltage range, $V_O$ (see Note 1) .....	-0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) .....	$\pm 20$ mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ or $V_O > V_{CC}$ ) .....	$\pm 50$ mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) .....	$\pm 50$ mA
Continuous current through $V_{CC}$ or GND .....	$\pm 150$ mA
Storage temperature range .....	$-65^\circ\text{C}$ to $150^\circ\text{C}$

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

# 74AC1174 HEX D-TYPE FLIP-FLOP WITH CLEAR

SCAS146 – MARCH 1990 – REVISED APRIL 1993

## recommended operating conditions

		MIN	NOM	MAX	UNIT
$V_{CC}$	Supply voltage	3	5	5.5	V
$V_{IH}$	High-level input voltage	$V_{CC} = 3\text{ V}$	2.1		V
		$V_{CC} = 4.5\text{ V}$	3.15		
		$V_{CC} = 5.5\text{ V}$	3.85		
$V_{IL}$	Low-level input voltage	$V_{CC} = 3\text{ V}$		0.9	V
		$V_{CC} = 4.5\text{ V}$		1.35	
		$V_{CC} = 5.5\text{ V}$		1.65	
$V_I$	Input voltage	0		$V_{CC}$	V
$V_O$	Output voltage	0		$V_{CC}$	V
$I_{OH}$	High-level output current	$V_{CC} = 3\text{ V}$		-4	mA
		$V_{CC} = 4.5\text{ V}$		-24	
		$V_{CC} = 5.5\text{ V}$		-24	
$I_{OL}$	Low-level output current	$V_{CC} = 3\text{ V}$		12	mA
		$V_{CC} = 4.5\text{ V}$		24	
		$V_{CC} = 5.5\text{ V}$		24	
$\Delta t/\Delta v$	Input transition rise or fall rate	0		10	ns/V
$T_A$	Operating free-air temperature	-40		85	°C

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	$V_{CC}$	$T_A = 25^\circ\text{C}$			MIN	MAX	UNIT
			MIN	TYP	MAX			
$V_{OH}$	$I_{OH} = -50\ \mu\text{A}$	3 V	2.9		2.9	V		
		4.5 V	4.4		4.4			
		5.5 V	5.4		5.4			
	$I_{OH} = -4\ \text{mA}$	3 V	2.58		2.48			
		4.5 V	3.94		3.8			
		5.5 V	4.94		4.8			
$I_{OH} = -75\ \text{mA}^\dagger$	5.5 V			3.85				
$V_{OL}$	$I_{OL} = 50\ \mu\text{A}$	3 V			0.1	0.1	V	
		4.5 V			0.1	0.1		
		5.5 V			0.1	0.1		
	$I_{OL} = 12\ \text{mA}$	3 V			0.36	0.44		
		4.5 V			0.36	0.44		
		5.5 V			0.36	0.44		
$I_{OL} = 75\ \text{mA}^\dagger$	5.5 V				1.65			
$I_I$	$V_I = V_{CC}$ or GND	5.5 V			$\pm 0.1$	$\pm 1$	$\mu\text{A}$	
$I_{CC}$	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8	80	$\mu\text{A}$	
$C_i$	$V_I = V_{CC}$ or GND	5 V		4			pF	

$^\dagger$  Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

# 74AC11174

## HEX D-TYPE FLIP-FLOP WITH CLEAR

SCAS146 – MARCH 1990 – REVISED APRIL 1993

timing requirements over recommended operating free-air temperature range,  $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted) (see Figure 1)

		$T_A = 25^\circ\text{C}$		MIN	MAX	UNIT
		MIN	MAX			
$f_{\text{clock}}$	Clock frequency	0	80	0	80	MHz
$t_w$	Pulse duration	$\overline{\text{CLR}}$ low	4.5	4.5		ns
		CLK high or low	6	6		
$t_{\text{su}}$	Setup time before $\text{CLK}\uparrow$	Data	7	7		ns
		$\overline{\text{CLR}}$ inactive	1.5	1.5		
$t_h$	Hold time after $\text{CLK}\uparrow$	0		0		ns

timing requirements over recommended operating free-air temperature range,  $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 1)

		$T_A = 25^\circ\text{C}$		MIN	MAX	UNIT
		MIN	MAX			
$f_{\text{clock}}$	Clock frequency	0	100	0	100	MHz
$t_w$	Pulse duration	$\overline{\text{CLR}}$ low	4	4		ns
		CLK high or low	5	5		
$t_{\text{su}}$	Setup time before $\text{CLK}\uparrow$	Data	4.5	4.5		ns
		$\overline{\text{CLR}}$ inactive	1.5	1.5		
$t_h$	Hold time after $\text{CLK}\uparrow$	0		0		ns

switching characteristics over recommended operating free-air temperature range,  $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			MIN	MAX	UNIT
			MIN	TYP	MAX			
$f_{\text{max}}$			80	105		80		MHz
$t_{\text{PHL}}$	$\overline{\text{CLR}}$	Any Q	3.9	10	13.5	3.9	14.8	ns
$t_{\text{PLH}}$	CLK	Any Q	2.4	7.5	9.2	2.4	10.8	ns
$t_{\text{PHL}}$			3.4	9.6	12.7	3.4	14	

switching characteristics over recommended operating free-air temperature range,  $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$  (unless otherwise noted) (see Figure 1)

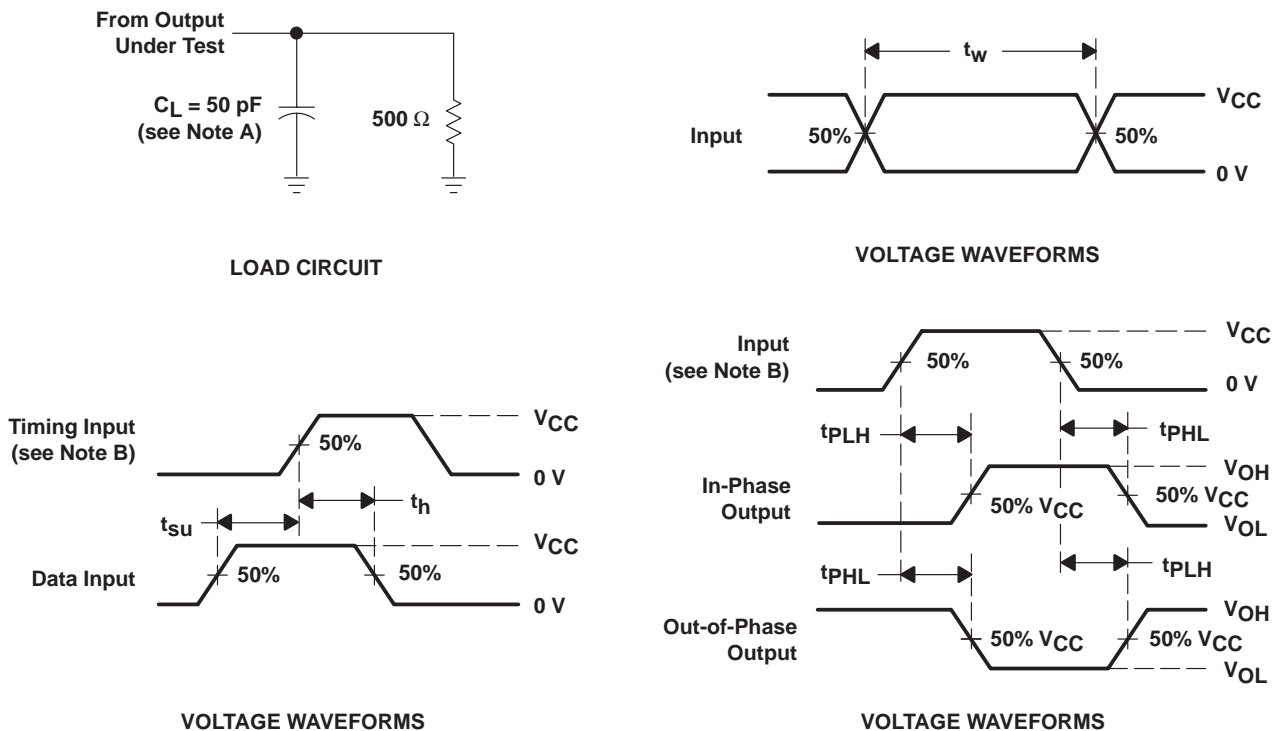
PARAMETER	FROM (INPUT)	TO (OUTPUT)	$T_A = 25^\circ\text{C}$			MIN	MAX	UNIT
			MIN	TYP	MAX			
$f_{\text{max}}$			100	125		100		MHz
$t_{\text{PHL}}$	$\overline{\text{CLR}}$	Any Q	2.9	6.5	9.8	2.9	10.7	ns
$t_{\text{PLH}}$	CLK	Any Q	2.1	4.9	6.8	2.1	7.6	ns
$t_{\text{PHL}}$			2.7	6.2	9.2	2.7	10.1	

operating characteristics,  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT	
$C_{\text{pd}}$	Power dissipation capacitance	$C_L = 50\text{ pF}$ , $f = 1\text{ MHz}$	29	pF



PARAMETER MEASUREMENT INFORMATION



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r = 3 \text{ ns}$ ,  $t_f = 3 \text{ ns}$ .  
 C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



## IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.